

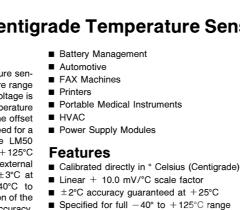
LM50B/LM50C SOT-23 Single-Supply Centigrade Temperature Sensor

General Description

The LM50 is a precision integrated-circuit temperature sensor that can sense a -40°C to +125°C temperature range using a single positive supply. The LM50's output voltage is linearly proportional to Celsius (Centigrade) temperature (+10 mV/°C) and has a DC offset of +500 mV. The offset allows reading negative temperatures without the need for a negative supply. The ideal output voltage of the LM50 ranges from +100 mV to +1.75V for a -40°C to +125°C temperature range. The LM50 does not require any external calibration or trimming to provide accuracies of $\pm 3^\circ\text{C}$ at room temperature and $\pm 4^{\circ}C$ over the full $-40^{\circ}C$ to +125°C temperature range. Trimming and calibration of the LM50 at the wafer level assure low cost and high accuracy. The LM50's linear output, +500 mV offset, and factory calibration simplify circuitry required in a single supply environment where reading negative temperatures is required. Because the LM50's quiescent current is less than 130 μ A, self-heating is limited to a very low 0.2°C in still air.

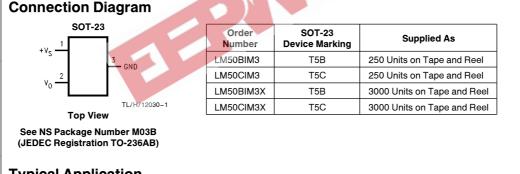
Applications

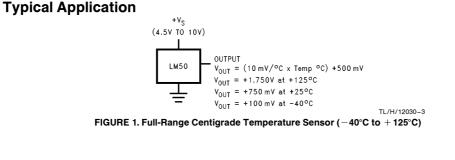
- Computers
- Disk Drives



- Specified for full -40° to +125°C range
- Suitable for remote applications
- Low cost due to wafer-level trimming
- Operates from 4.5V to 10V

- Less than 130 µA current drain
- Low self-heating, less than 0.2°C in still air
- Nonlinearity less than 0.8°C over temp





© 1996 National Semiconductor Corporation TL/H/12030 RRD-B30M76/Printed in U. S. A.

http://www.national.com

June 1996

Absolute Maximum	Ratings	(Note 1)
------------------	---------	----------

Supply Voltage	+ 12V to -0.2V	
Output Voltage	$(+V_{\rm S}$ + 0.6V) to -1.0V	
Output Current	10 mA	
Storage Temperature	-65°C to +150°C	
Lead Temperature		
SOT Package (Note 2):		
Vapor Phase (60 seconds)	215°C	
Infrared (15 seconds)	220°C	
T _{JMAX} , Maximum Junction Temper	ature 150°C	

ESD Susceptibility (Note 3): Human Body Model Machine Model	2000V 200V
Operating Ratings (Note 1)	

Specified Temperature Range: T_{MIN} to T_{MAX} LM50C -40°C to +125°C LM50B -25°C to +100°C

LIVIOUB	-25° C 10 \pm 100°C
Operating Temperature Range	-40°C to +150°C
θ_{JA} (Note 4)	450°C/W
Supply Voltage Range ($+$ V _S)	+4.5V to $+10V$

Electrical Characteristics Unless otherwise noted, these specifications apply for $V_S = +5 V_{DC}$ and $I_{LOAD} = +0.5 \mu$ A, in the circuit of *Figure 1*. **Boldface limits apply for the specified** $T_A = T_J = T_{MIN}$ to T_{MAX} ; all other limits $T_A = T_J = +25^{\circ}$ C, unless otherwise noted.

	Conditions	LM50B		LM50C		Units
Parameter		Typical	Limit (Note 5)	Typical	Limit (Note 5)	(Limit)
Accuracy (Note 6)	$ \begin{array}{l} T_{A}=\ +\ 25^{\circ}C\\ T_{A}=\ T_{MAX}\\ T_{A}=\ T_{MIN} \end{array} $		±2.0 ±3.0 +3.0, -3.5		±3.0 ±4.0 ±4.0	°C (max) °C (max) °C (max)
Nonlinearity (Note 7)			± 0.8	A.	± 0.8	°C (max)
Sensor Gain (Average Slope)			+ 9.7 + 10.3 🧹	A ST	+ 9.7 + 10.3	mV/°C (min) mV/°C (max)
Output Resistance		2000	4000	2000	4000	Ω (max)
Line Regulation (Note 8)	$+4.5V \le V_S \le +10V$		±0.8 ± 1.2	:01	±0.8 ±1.2	mV/V (max) mV/V (max)
Quiescent Current (Note 9)	$+4.5V \le V_S \le +10V$		130 180		130 180	μΑ (max) μΑ (max)
Change of Quiescent Current (Note 8)	$+4.5V \le V_S \le +10V$		2.0		2.0	μA (max)
Temperature Coefficient of Quiescent Current		+ 1.0		+ 2.0		μA/°C
Long Term Stability (Note 10)	$T_J = 125^{\circ}C$, for 1000 hours	±0.08		±0.08		°C

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its rated operating conditions.

Note 2: See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" or the section titled "Surface Mount" found in a current National Semiconductor Linear Data Book for other methods of soldering surface mount devices.

Note 3: Human body model, 100 pF discharged through a 1.5 k Ω resistor. Machine model, 200 pF discharged directly into each pin.

Note 4: Thermal resistance of the SOT-23 package is specified without a heat sink, junction to ambient.

Note 5: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

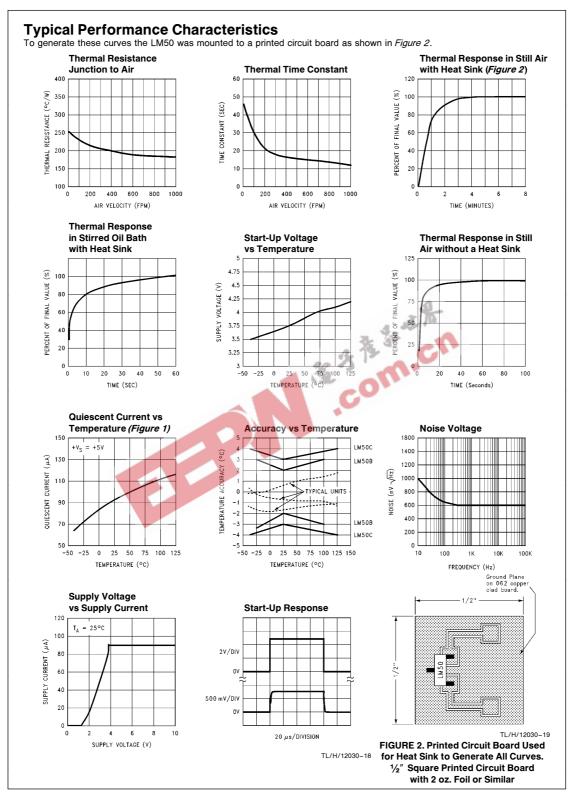
Note 6: Accuracy is defined as the error between the output voltage and 10mv/°C times the device's case temperature, at specified conditions of voltage, current, and temperature (expressed in °C).

Note 7: Nonlinearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line, over the device's rated temperature range.

Note 8: Regulation is measured at constant junction temperature, using pulse testing with a low duty cycle. Changes in output due to heating effects can be computed by multiplying the internal dissipation by the thermal resistance.

Note 9: Quiescent current is defined in the circuit of Figure 1.

Note 10: For best long-term stability, any precision circuit will give best results if the unit is aged at a warm temperature, and/or temperature cycled for at least 46 hours before long-term life test begins. This is especially true when a small (Surface-Mount) part is wave-soldered; allow time for stress relaxation to occur. The majority of the drift will occur in the first 1000 hours at elevated temperatures. The drift after 1000 hours will not continue at the first 1000 hour rate.



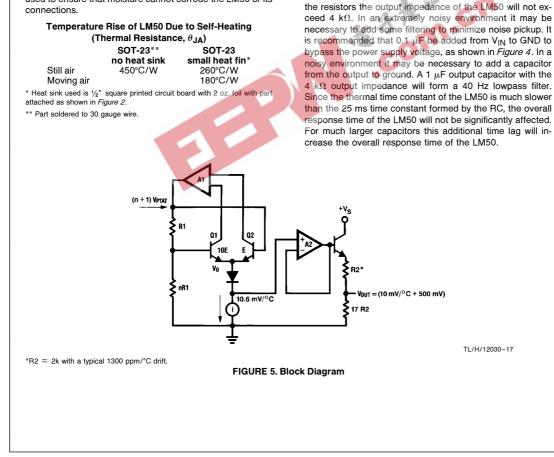
1.0 Mounting

The LM50 can be applied easily in the same way as other integrated-circuit temperature sensors. It can be glued or cemented to a surface and its temperature will be within about 0.2°C of the surface temperature.

This presumes that the ambient air temperature is almost the same as the surface temperature; if the air temperature were much higher or lower than the surface temperature, the actual temperature of the LM50 die would be at an intermediate temperature between the surface temperature and the air temperature.

To ensure good thermal conductivity the backside of the LM50 die is directly attached to the GND pin. The lands and traces to the LM50 will, of course, be part of the printed circuit board, which is the object whose temperature is being measured. These printed circuit board lands and traces will not cause the LM50s temperature to deviate from the desired temperature.

Alternatively, the LM50 can be mounted inside a sealed-end metal tube, and can then be dipped into a bath or screwed into a threaded hole in a tank. As with any IC, the LM50 and accompanying wiring and circuits must be kept insulated and dry, to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. Printed-circuit coatings and varnishes such as Humiseal and epoxy paints or dips are often used to ensure that moisture cannot corrode the LM50 or its connections.



2.0 Capacitive Loads

HEAVY CAPACITIVE LOAD, WIRING, ETC.

FIGURE 3. LM50 No Decoupling Required

for Capacitive Load

FIGURE 4. LM50C with Filter for Noisy Environment

The LM50 handles capacitive loading very well. Without any

special precautions, the LM50 can drive any capacitive load.

The LM50 has a nominal 2 k Ω output impedance (as can be

seen in the block diagram). The temperature coefficient of

the output resistors is around 1300 ppm/°C. Taking into ac-

count this temperature coefficient and the initial tolerance of

LM50

0.1 µF BYPASS Optional TO A HIGH-IMPEDANCE LOAD

HEAVY CAPACITIVE LOAD, WIRING, ETC.

1 1

TI /H/12030-7

TL/H/12030-8

